250W,50V High Power RF LDMOS FETs

Description

The ITEV05251C9 is a 250watt capable, high performance, internally matched LDMOS FET, designed for RF Energy or ISM application centered at 433MHz, in cost effective 12*10mm QFN plastic package,

It can be soldered on PCB through high density grounding vias or soldered directly on heatsink, according to different applications.





Typical CW performance(on Innogration test board with device soldered on heatsink directly)
50V, Idq=1mA

Freq	P1dB	P1dB	P1dB	P1dB	P3dB	P3dB	P3dB
(MHz)	(dBm)	(W)	Eff(%)	Gain(dB)	(dBm)	(W)	Eff(%)
433	53.39	218.4	73.9	20.76	53.99	250.5	74.5

40V, Idq=1mA

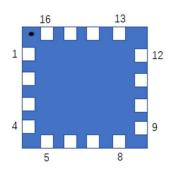
Freq	P1dB	P1dB	P1dB	P1dB	P3dB	P3dB	P3dB
(MHz)	(dBm)	(W)	Eff(%)	Gain(dB)	(dBm)	(W)	Eff(%)
433	51.37	137.0	71.8	19.45	52.22	165	73

Recommended driver: ITGV22010C6

Features

- High Efficiency and Linear Gain Operations
- Integrated ESD Protection
- Excellent thermal stability, low HCl drift
- Large Positive and Negative Gate/Source Voltage Range for Improved Class C Operation
- Pb-free, RoHS-compliant

Pin Configuration and Description (Top view)



Pin No.	Symbol	Description
5-8	RF IN/Vgs	RF Input/Gate bias
13-16	RF OUT/Vds	RF Output/Drain bias
Others	NC	Can be left as either no use or grounding
		DC/RF Ground. Proposed to be soldered to heatsink plane directly for the best CW thermal
Package Base	GND	and RF performance. Soldered through vias or copper coin allowed for pulsed CW
		applications, but will result in excessive junction temperatures and different RF performance

Table 1. Maximum Ratings

Rating	Symbol	Value	Unit
DrainSource Voltage	V _{DSS}	+110	Vdc
GateSource Voltage	V _{GS}	-10 to +10	Vdc
Operating Voltage	V _{DD}	+55	Vdc
Storage Temperature Range	Tstg	-65 to +150	°C
Case Operating Temperature	T _c	+150	°C
Operating Junction Temperature	TJ	+225	°C

Table 2. Thermal Characteristics

Characteristic	Symbol	Value	Unit
Thermal Resistance, Junction to Case	Do 10	0.7	00/14/
T _C = 85°C, T _J =200°C, DC test, soldered on heatsink	Rejc	0.7	°C/W

Table 3. ESD Protection Characteristics

Test Methodology	Class
Human Body Model (per JESD22A114)	Class 2

Table 4. Electrical Characteristics (T_A = 25 $^{\circ}$ C unless otherwise noted)

Characteristic	Symbol	Min	Тур	Max	Unit
DC Characteristics (per half section)					
Drain-Source Voltage			440		V
V _{GS} =0, I _{DS} =1.0mA	V _{(BR)DSS}		110		V
Zero Gate Voltage Drain Leakage Current				1	^
$(V_{DS} = 75V, V_{GS} = 0 V)$	I _{DSS}			l I	μΑ
Zero Gate Voltage Drain Leakage Current				1	^
$(V_{DS} = 50V, V_{GS} = 0 V)$	I _{DSS}			I	μΑ
GateSource Leakage Current				1	^
$(V_{GS} = 10 \text{ V}, V_{DS} = 0 \text{ V})$	I _{GSS}			I	μΑ
Gate Threshold Voltage	\/ (46)		2.65		V
$(V_{DS} = 50V, I_D = 600 \mu A)$	V _{GS} (th)		2.00		V
Gate Quiescent Voltage	V		3.7		V
(V _{DD} =50 V, I _D = 500 mA, Measured in Functional Test)	$V_{GS(Q)}$		5.7		V

 $\textbf{Load Mismatch (In Innogration Test Fixture, 50 ohm system):} \ V_{DD} = 50 \ Vdc, \ I_{DQ} = 200 \ mA, \ f = 433 MHz, \ pulse \ width: 100us, \ duty \ cycle: 10\% \ A = 200 \ mA, \ f = 433 MHz, \ pulse \ width: 100us, \ duty \ cycle: 10\% \ A = 200 \ mA, \ f = 433 MHz, \ pulse \ width: 100us, \ duty \ cycle: 10\% \ A = 200 \ mA, \ f = 433 MHz, \ pulse \ width: 100us, \ duty \ cycle: 10\% \ A = 200 \ mA, \ f = 433 MHz, \ pulse \ width: 100us, \ duty \ cycle: 10\% \ A = 200 \ mA, \ f = 433 MHz, \ pulse \ width: 100us, \ duty \ cycle: 10\% \ A = 200 \ mA, \ f = 433 MHz, \ pulse \ width: 100us, \ duty \ cycle: 10\% \ A = 200 \ mA, \ f = 433 MHz, \ pulse \ width: 100us, \ duty \ cycle: 10\% \ A = 200 \ mA, \ f = 433 MHz, \ pulse \ width: 100us, \ duty \ cycle: 10\% \ A = 200 \ mA, \ f = 433 MHz, \ pulse \ width: 100us, \ duty \ cycle: 10\% \ A = 200 \ mA, \ f = 433 MHz, \ pulse \ width: 100us, \ duty \ cycle: 10\% \ A = 200 \ mA, \ f = 433 MHz, \ pulse \ width: 100us, \ duty \ cycle: 10\% \ A = 200 \ mA, \ f = 433 MHz, \ pulse \ width: 100us, \ duty \ cycle: 10\% \ A = 200 \ mA, \ f = 433 MHz, \ pulse \ width: 100us, \ duty \ cycle: 10\% \ A = 200 \ mA, \ f = 433 MHz, \ pulse \ width: 100us, \ duty \ cycle: 10\% \ A = 200 \ mA, \ f = 200 \ mA$

Load 10:1 All phase angles, at 250W Pulsed CW Output Power	No Device Degradation
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TYPICAL CHARACTERISTICS

Figure 1: CW Gain and Power Efficiency as a Function of Pout at 433MHz

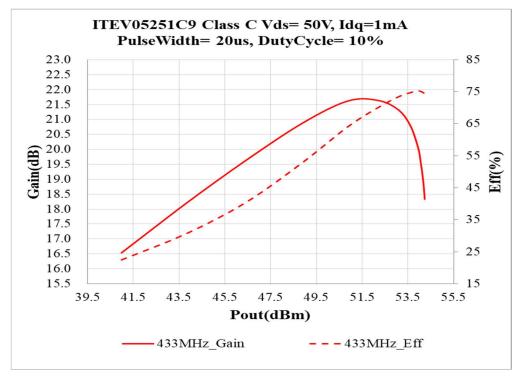
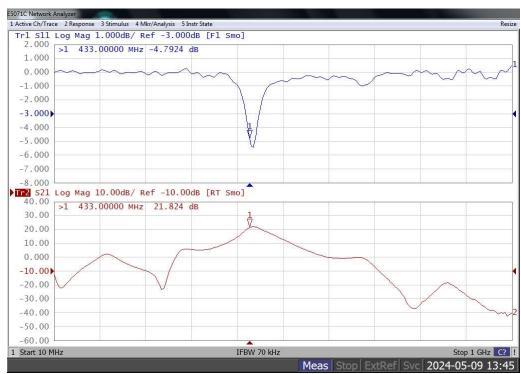
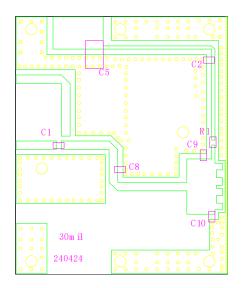
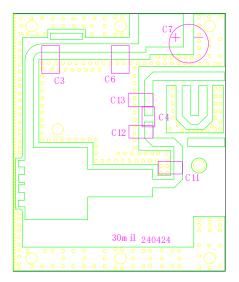


Figure 2: Network analyzer output S11/221



Reference Circuit of Test Fixture Assembly Diagram





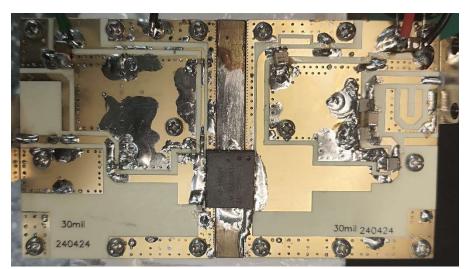
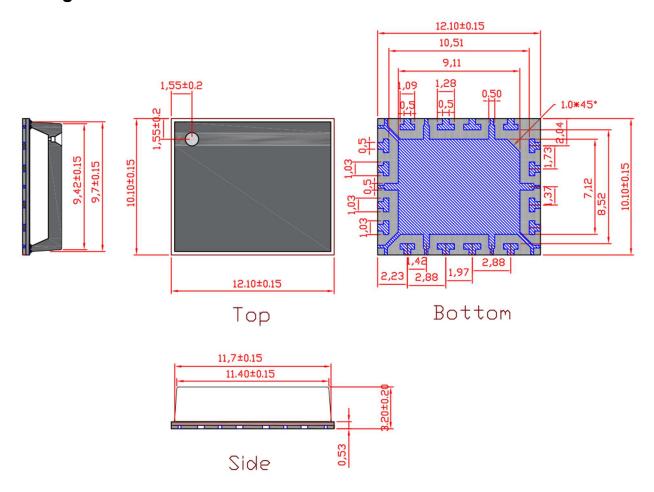


Table 5. Test Circuit Component Designations and Values

Designator	Comment	Footprint	Quantity
C1	3.9 pF(High Q)	0603	1
C2	100 pF (High Q)	0603	1
C3, C4	100 pF (High Q)	1210	2
C5, C6	10 uF/100V	1210	2
C7	470 uF/63V		1
C8, C9	20 pF (High Q)	0603	2
C10	30 pF (High Q)	0603	1
C11	3.9 pF (High Q)	1210	1
C12	1.8 pF (High Q)	1210	1
C13	15 pF (High Q)	1210	1
R1	10 Ω	0603	1

Package Dimensions (Unit:mm)



Revision history

Table 5. Document revision history

Date	Revision	Datasheet Status
2024/5/9	Rev 1.0	Preliminary Datasheet Creation

Application data based on LSM-24-16

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